November 2002

## 54ABT543 **Octal Registered Transceiver with TRI-STATE® Outputs** A and B outputs have current sourcing capability of 24

mA and current sinking capability of 48 mA

Guaranteed latchup protection

power up and power down cycle

Nondestructive hot insertion capability

Separate controls for data flow in each direction

High impedance glitch free bus loading during entire

Standard Military Drawing (SMD) 5962-9231401

## **General Description**

The 'ABT543 octal transceiver contains two sets of D-type latches for temporary storage of data flowing in either direction. Separate Latch Enable and Output Enable inputs are provided for each register to permit independent control of inputting and outputting in either direction of data flow.

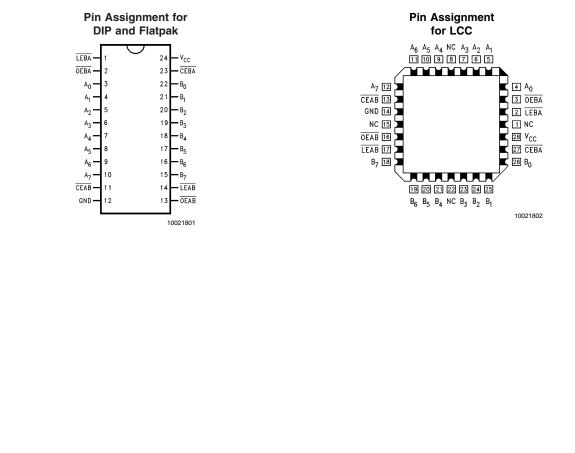
## Features

- Back-to-back registers for storage
- Bidirectional data path

## Ordering Code:

Military	Package	Package Description
	Number	
54ABT543J-QML	J24F	24-Lead Ceramic Dual-In-Line
54ABT543W-QML	W24C	24-Lead Cerpack
54ABT543E-QML	E28A	28-Lead Ceramic Leadless Chip Carrier, Type C

## **Connection Diagrams**



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### **Pin Descriptions**

Pin Names	Description
OEAB, OEBA	Output Enable Inputs
LEAB , LEBA	Latch Enable Inputs
CEAB, CEBA	Chip Enable Inputs
A <sub>0</sub> -A <sub>7</sub>	Side A Inputs or
	TRI-STATE Outputs
B <sub>0</sub> -B <sub>7</sub>	Side B Inputs or
	TRI-STATE Outputs

## **Functional Description**

The 'ABT543 contains two sets of D-type latches, with separate input and output controls for each. For data flow from A to B, for example, the A to B Enable (CEAB) input must be low in order to enter data from the A port or take data from the B port as indicated in the Data I/O Control Table. With CEAB low, a low signal on (LEAB) input makes the A to B latches transparent; a subsequent low to high transition of the LEAB line puts the A latches in the storage mode and their outputs no longer change with the A inputs. With CEAB and OEAB both low, the B output buffers are active and reflect the data present on the output of the A latches. Control of data flow from B to A is similar, but using the CEBA, LEBA and OEBA.

#### Data I/O Control Table

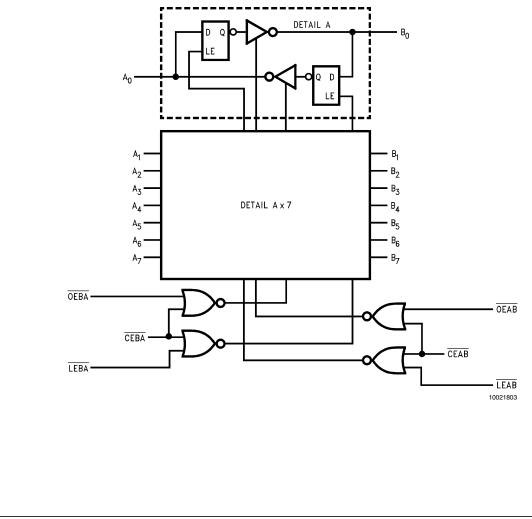
	Inputs		Latch Status	Output
CEAB	LEAB	OEAB		Buffers
Н	Х	Х	Latched	High Z
Х	Н	Х	Latched	—
L	L	Х	Transparent	—
Х	Х	Н	—	High Z
L	Х	L	_	Driving

H = High Voltage Level

L = Low Voltage Level

X = Immaterial

## Logic Diagram



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54ABT543

## Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Storage Temperature	–65°C to +150°C
Ambient Temperature under Bias	–55°C to +125°C
Junction Temperature under Bias	
Ceramic	–55°C to +175°C
V <sub>CC</sub> Pin Potential to	
Ground Pin	-0.5V to +7.0V
Input Voltage (Note 2)	-0.5V to +7.0V
Input Current (Note 2)	-30 mA to +5.0
	mA
Voltage Applied to Any Output	
in the Disable or Power-Off State	-0.5V to +5.5V
in the HIGH State	–0.5V to $V_{\rm CC}$
Current Applied to Output	

in LOW State (Max) twice the rated I<sub>OL</sub> (mA) DC Latchup Source Current -500 mA Over Voltage Latchup (I/O) 10V 54ABT543

# Recommended Operating Conditions

–55°C to +125°C
+4.5V to +5.5V
$(\Delta V / \Delta t)$
50 mV/ns
20 mV/ns
100 mV/ns

## **DC Electrical Characteristics**

Symbol	Parameter		ABT54	3	Units	V <sub>cc</sub>	Conditions
		Min	Тур	Max			
V <sub>IH</sub>	Input HIGH Voltage	2.0			V		Recognized HIGH Signal
V <sub>IL</sub>	Input LOW Voltage			0.8	V		Recognized LOW Signal
V <sub>CD</sub>	Input Clamp Diode Voltage			-1.2	V	Min	I <sub>IN</sub> = -18 mA (Non I/O Pins)
V <sub>он</sub>	Output HIGH Voltage 54ABT	2.5					$I_{OH} = -3 \text{ mA}, (A_n, B_n)$
	54ABT	2.0			V	Min	$I_{OH} = -24 \text{ mA}, (A_n, B_n)$
V <sub>OL</sub>	Output LOW Voltage 54ABT			0.55	V	Min	$I_{OL} = 48 \text{ mA}, (A_n, B_n)$
V <sub>ID</sub>	Input Leakage Test	4.75			V	0.0	I <sub>ID</sub> = 1.9 μA, (Non-I/O Pins)
							All Other Pins Grounded
I <sub>IH</sub>	Input HIGH Current			5	μΑ	Max	V <sub>IN</sub> = 2.7V (Non-I/O Pins) (Note 3)
							$V_{IN} = V_{CC}$ (Non-I/O Pins)
I <sub>BVI</sub>	Input HIGH Current Breakdown Test			7	μA	Max	$V_{IN} = 7.0V$ (Non-I/O Pins)
I <sub>bvit</sub>	Input HIGH Current			100	μA	Max	$V_{IN} = 5.5V (A_n, B_n)$
	Breakdown Test (I/O)						
I	Input LOW Current			-5	μA	Max	V <sub>IN</sub> = 0.5V (Non-I/O Pins)(Note 3)
							V <sub>IN</sub> = 0.0V (Non-I/O Pins)
I <sub>IH</sub> + I <sub>OZH</sub>	Output Leakage Current			50	μA	0V-5.5V	$V_{OUT} = 2.7V (A_n, B_n);$ $\overline{OEAB} \text{ or } \overline{CEAB} = 2V$
$I_{IL} + I_{OZL}$	Output Leakage Current			-50	μΑ	0V-5.5V	$\frac{V_{OUT} = 0.5V (A_n, B_n);}{OEAB \text{ or } CEAB} = 2V$
l <sub>os</sub>	Output Short-Circuit Current	-100		-275	mA	Max	$V_{OUT} = 0V (A_n, B_n)$
I <sub>CEX</sub>	Output HIGH Leakage Current			50	μA	Max	$V_{OUT} = V_{CC} (A_n, B_n)$
IZZ	Bus Drainage Test			100	μΑ	0.0V	$V_{OUT} = 5.5V (A_n, B_n);$
							All Others GND
I <sub>CCLH</sub>	Power Supply Current			50	μA	Max	All Outputs HIGH
I <sub>CCL</sub>	Power Supply Current			30	mA	Max	All Outputs LOW
I <sub>ccz</sub>	Power Supply Current			50	μA	Max	Outputs TRI-STATE
							All Others at V <sub>CC</sub> or GND

## **DC Electrical Characteristics** (Continued)

Symbol	Parameter		ABT543 Unit		ABT543		Units	V <sub>cc</sub>	Conditions
		Min	Тур	Max					
I <sub>CCT</sub>	Additional I <sub>CC</sub> /Input			2.5	mA	Max	$V_{1} = V_{CC} - 2.1V$		
							All Others at $V_{CC}$ or GND		
CCD	Dynamic I <sub>CC</sub> No Load						Outputs Open, CEAB		
	(Note 3)			0.18	mA/MHz	Max	and $\overline{OEAB} = GND, \overline{CEBA} =$		
							V <sub>CC</sub> , One Bit Toggling,		
							50% Duty Cycle, (Note 4)		

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

Note 3: Guaranteed but not tested.

Note 4: For 8-bit toggling.  $I_{CCD} < 1.4 \text{ mA/MHz}.$ 

# **DC Electrical Characteristics**

						Conditions
Symbol	Parameter	Min	Max	Units	V <sub>cc</sub>	C <sub>L</sub> = 50 pF,
						<b>R</b> <sub>L</sub> = 500Ω
V <sub>OLP</sub>	Quiet Output Maximum Dynamic V <sub>OL</sub>		1.1	V	5.0	$T_A = 25^{\circ}C$ (Note 5)
V <sub>OLV</sub>	Quiet Output Minimum Dynamic V <sub>OL</sub>		-0.45	V	5.0	$T_A = 25^{\circ}C(Note 5)$

Note 5: Max number of outputs defined as (n). n - 1 data inputs are driven 0V to 3V. One output at LOW.

## **AC Electrical Characteristics**

Symbol	Parameter	$54ABT$ $T_{A} = -55^{\circ}C \text{ to } +125^{\circ}C$ $V_{CC} = 4.5V - 5.5V$ $C_{L} = 50 \text{ pF}$		Units	Fig. No.
	-	Min	орг Мах	_	
t <sub>PLH</sub>	Propagation Delay	1.6	6.4	ns	Figure 4
t <sub>PHL</sub>	$A_n$ to $B_n$ or $B_n$ to $A_n$	1.6	6.2		
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay $\overline{\text{LEAB}}$ to B <sub>n</sub> , $\overline{\text{LEBA}}$ to A <sub>n</sub>	1.6	6.6	ns	Figure 4
	$\overline{OEBA}$ or $\overline{OEAB}$ to $A_n$ or $B_n$	1.6	6.4		
t <sub>PZH</sub> t <sub>PZL</sub>	Enable Time $\overline{\text{LEAB}}$ to $B_n$ , $\overline{\text{LEBA}}$ to $A_n$	1.3	6.4	ns	Figure 6
	$\overline{OEBA}$ or $\overline{OEAB}$ to $A_n$ or $B_n$	1.8	7.4		
t <sub>PHZ</sub>	Disable Time	2.0	7.2	ns	Figure 6
t <sub>PLZ</sub>	$\overline{CEBA}$ or $\overline{CEAB}$ to $A_n$ or $B_n$	1.5	7.0		

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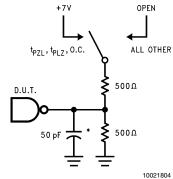
		54ABT		_	Fig
Symbol	Parameter		T <sub>A</sub> = -55°C to +125°C V <sub>CC</sub> = 4.5V-5.5V		Fig.
Cymbol			50 pF	Units	
		Min	Max	-	
t <sub>s</sub> (H)	Setup Time, HIGH or LOW	3.5		ns	Figure 7
t <sub>S</sub> (L)	$A_n$ or $B_n$ to LEBA or LEAB	3.0			
t <sub>H</sub> (H)	Hold Time, HIGH or LOW	2.0		ns	Figure 7
t <sub>H</sub> (L)	$A_n$ or $B_n$ to $\overline{LEBA}$ or $\overline{LEAB}$	2.0			
t <sub>S</sub> (H)	Setup Time, HIGH or LOW	3.3		ns	Figure 7
t <sub>s</sub> (L)	$A_n$ or $B_n$ to $\overline{CEAB}$ or $\overline{CEBA}$	2.5			
t <sub>H</sub> (H)	Hold Time, HIGH or LOW	2.0		ns	Figure 7
t <sub>H</sub> (L)	$A_n$ or $B_n$ to $\overline{CEAB}$ or $\overline{CEBA}$	2.0			

# Capacitance

Symbol	Parameter	Тур	Units	Conditions: T <sub>A</sub> = 25°C
C <sub>IN</sub>	Input Capacitance	5.0	pF	$V_{CC} = 0V$ (non I/O pins)
C <sub>I/O</sub> (Note 6)	Output Capacitance	11.0	pF	$V_{\rm CC} = 5.0 V (A_{\rm n}, B_{\rm n})$

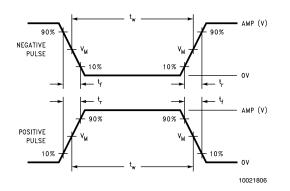
Note 6:  $C_{I/O}$  is measured at frequency, f = 1 MHz, PER MIL-STD-883, METHOD 3012.

# AC Loading



\*Includes jig and probe capacitance

### FIGURE 1. Standard AC Test Load

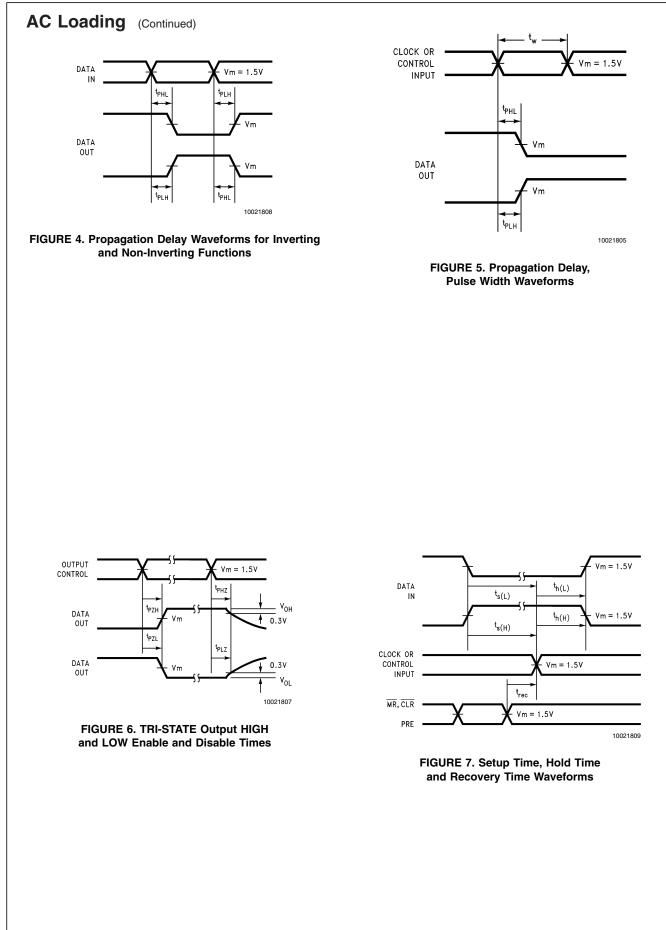


#### FIGURE 2. $V_M = 1.5V$ Input Pulse Requirements

Amplitude	Rep. Rate	t <sub>w</sub>	t <sub>r</sub>	t <sub>f</sub>
3V	1 MHz	500 ns	2.5 ns	2.5 ns

#### FIGURE 3. Test Input Signal Requirements

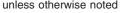
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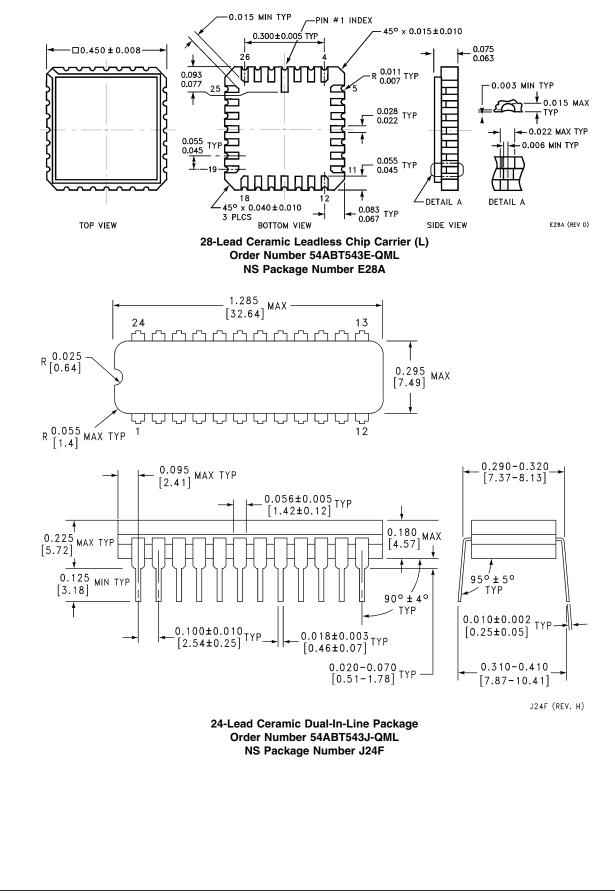


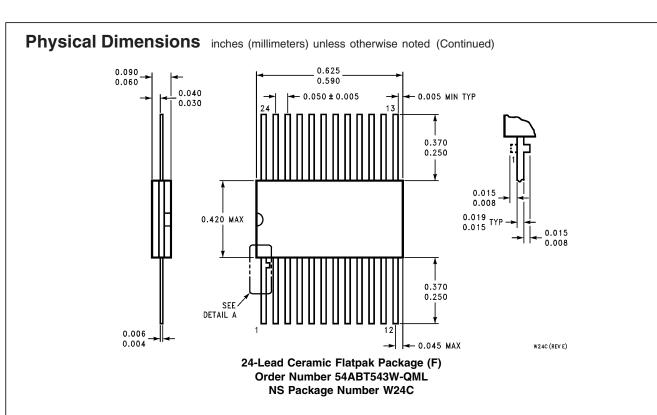
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# Physical Dimensions inches (millimeters) unless otherwise noted

54ABT543







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